74HC238-Q100; 74HCT238-Q100

3-to-8 line decoder/demultiplexer

Rev. 3 — 3 April 2020

Product data sheet

1. General description

The 74HC238-Q100; 74HCT238-Q100 decodes three binary weighted address inputs (A0, A1 and A2) to eight mutually exclusive outputs (Y0 to Y7). The device features three enable inputs (E1 and E2 and E3). Every output will be LOW unless E1 and E2 are LOW and E3 is HIGH. This multiple enable function allows easy parallel expansion to a 1-of-32 (5 to 32 lines) decoder with just four '238 ICs and one inverter. The '238 can be used as an eight output demultiplexer by using one of the active LOW enable inputs as the data input and the remaining enable inputs as strobes. Inputs include clamp diodes. This enables the use of current limiting resistors to interface inputs to voltages in excess of V_{CC} .

This product has been qualified to the Automotive Electronics Council (AEC) standard Q100 (Grade 1) and is suitable for use in automotive applications.

2. Features and benefits

- Automotive product qualification in accordance with AEC-Q100 (Grade 1)
 - Specified from -40 °C to +85 °C and from -40 °C to +125 °C
- · Demultiplexing capability
- Multiple input enable for easy expansion
- · Ideal for memory chip select decoding
- · Active HIGH mutually exclusive outputs
- Multiple package options
- Complies with JEDEC standard no. 7A
- Input levels:
 - For 74HC238: CMOS level
 - For 74HCT238: TTL level
- ESD protection:
 - MIL-STD-883, method 3015 exceeds 2000 V
 - HBM JESD22-A114F exceeds 2000 V
 - MM JESD22-A115-A exceeds 200 V (C = 200 pF, R = 0 Ω)
- DHVQFN package with Side-Wettable Flanks enabling Automatic Optical Inspection (AOI) of solder joints

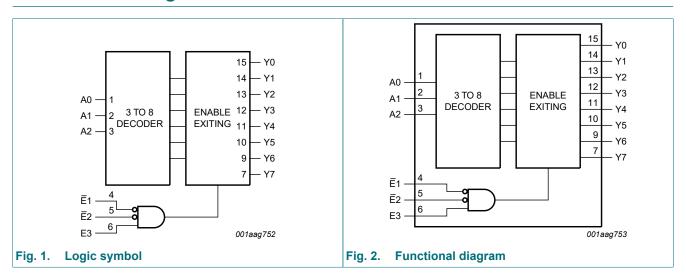
3. Ordering information

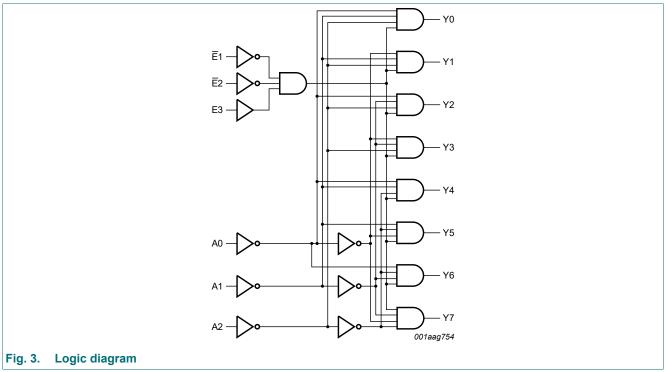
Table 1. Ordering information

Table 1. Ordering init					
Type number	Package				
	Temperature range	Name	Description	Version	
74HC238D-Q100	-40 °C to +125 °C	SO16	plastic small outline package; 16 leads;	SOT109-1	
74HCT238D-Q100	-		body width 3.9 mm		
74HC238PW-Q100	-40 °C to +125 °C	TSSOP16	plastic thin shrink small outline package; 16 leads;	SOT403-1	
74HCT238PW-Q100	-		body width 4.4 mm		
74HC238BQ-Q100	-40 °C to +125 °C	DHVQFN16	plastic dual in-line compatible thermal	SOT763-1	
74HCT238BQ-Q100	-		enhanced very thin quad flat package; no leads; 16 terminals; body 2.5 × 3.5 × 0.85 mm		



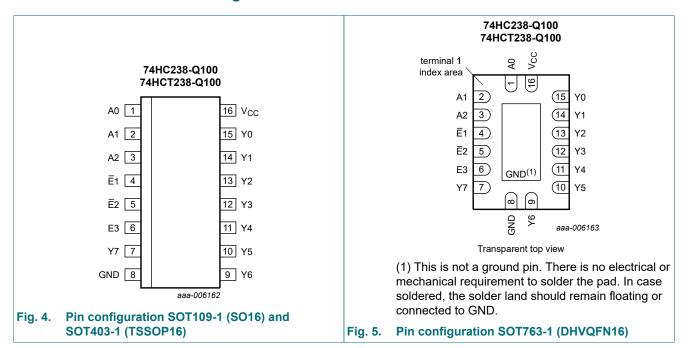
4. Functional diagram





5. Pinning information

5.1. Pinning



5.2. Pin description

Table 2. Pin description

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Symbol	Pin	Description
A0, A1, A2	1, 2, 3	address input
E1, E2	4, 5	enable input (active LOW)
E3	6	enable input (active HIGH)
Y0, Y1, Y2, Y3, Y4, Y5, Y6, Y7	15, 14, 13, 12, 11, 10, 9, 7	output
GND	8	ground (0 V)
V _{CC}	16	supply voltage

6. Functional description

Table 3. Function table

 $H = HIGH \ voltage \ level; \ L = LOW \ voltage \ level; \ X = don't \ care.$

Inputs						Outputs									
E1	Ē2	E3	A0	A1	A2	Y0	Y1	Y2	Y3	Y4	Y5	Y6	Y7		
Н	Х	Х	Х	Х	Х	L	L	L	L	L	L	L	L		
Χ	Н	Х	Х	Х	Х	L	L	L	L	L	L	L	L		
Χ	Х	L	Х	Х	Х	L	L	L	L	L	L	L	L		
L	L	Н	L	L	L	Н	L	L	L	L	L	L	L		
L	L	Н	Н	L	L	L	Н	L	L	L	L	L	L		
L	L	Н	L	Н	L	L	L	Н	L	L	L	L	L		
L	L	Н	Н	Н	L	L	L	L	Н	L	L	L	L		
L	L	Н	L	L	Н	L	L	L	L	Н	L	L	L		
L	L	Н	Н	L	Н	L	L	L	L	L	Н	L	L		
L	L	Н	L	Н	Н	L	L	L	L	L	L	Н	L		
L	L	Н	Н	Н	Н	L	L	L	L	L	L	L	Н		

7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V_{CC}	supply voltage		-0.5	+7	V
I _{IK}	input clamping current	$V_I < -0.5 \text{ V or } V_I > V_{CC} + 0.5 \text{ V}$ [1]	-	±20	mA
I _{OK}	output clamping current	$V_O < -0.5 \text{ V or } V_O > V_{CC} + 0.5 \text{ V}$ [1]	-	±20	mA
Io	output current	-0.5 V < V _O < V _{CC} + 0.5 V	-	±25	mA
I _{CC}	supply current		-	50	mA
I _{GND}	ground current		-50	-	mA
T _{stg}	storage temperature		-65	+150	°C
P _{tot}	total power dissipation	[2]	-	500	mW

^[1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

^[2] For SOT109-1 (SO16) package: P_{tot} derates linearly with 12.4 mW/K above 110 °C. For SOT403-1 (TSSOP16) package: P_{tot} derates linearly with 8.5 mW/K above 91 °C. For SOT763-1 (DHVQFN16) package: P_{tot} derates linearly with 11.2 mW/K above 106 °C.

8. Recommended operating conditions

Table 5. Recommended operating conditions

Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	741	HC238-Q	100	74H	Unit		
			Min	Тур	Max	Min	Тур	Max	
V _{CC}	supply voltage		2.0	5.0	6.0	4.5	5.0	5.5	V
VI	input voltage		0	-	V _{CC}	0	-	V _{CC}	V
Vo	output voltage		0	-	V _{CC}	0	-	Vcc	V
T _{amb}	ambient temperature		-40	-	+125	-40	-	+125	°C
Δt/ΔV	input transition rise and fall rate	V _{CC} = 2.0 V	-	-	625	-	-	-	ns/V
		V _{CC} = 4.5 V	-	1.67	139	-	1.67	139	ns/V
		V _{CC} = 6.0 V	-	-	83	-	-	-	ns/V

9. Static characteristics

Table 6. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		25 °C			°C to 5 °C		°C to 5 °C	Unit
			Min	Тур	Max	Min	Max	Min	Max	
74HC238	8-Q100							•		
V _{IH}	HIGH-level	V _{CC} = 2.0 V	1.5	1.2	-	1.5	-	1.5	-	V
	input voltage	V _{CC} = 4.5 V	3.15	2.4	-	3.15	-	3.15	-	V
		V _{CC} = 6.0 V	4.2	3.2	-	4.2	-	4.2	-	V
V _{IL}	LOW-level	V _{CC} = 2.0 V	-	0.8	0.5	-	0.5	-	0.5	V
	input voltage	V _{CC} = 4.5 V	-	2.1	1.35	-	1.35	-	1.35	V
		V _{CC} = 6.0 V	-	2.8	1.8	-	1.8	-	1.8	V
V _{OH}	HIGH-level	V _I = V _{IH} or V _{IL}								
	output voltage	I _O = -20 μA; V _{CC} = 2.0 V	1.9	2.0	-	1.9	-	1.9	-	V
		I _O = -20 μA; V _{CC} = 4.5 V	4.4	4.5	-	4.4	-	4.4	-	V
		I _O = -20 μA; V _{CC} = 6.0 V	5.9	6.0	-	5.9	-	5.9	-	V
		I _O = -4.0 mA; V _{CC} = 4.5 V	3.98	4.32	-	3.84	-	3.7	-	V
		I_{O} = -5.2 mA; V_{CC} = 6.0 V	5.48	5.81	-	5.34	-	5.2	-	V
V _{OL}	LOW-level	V _I = V _{IH} or V _{IL}								
	output voltage	I _O = 20 μA; V _{CC} = 2.0 V	-	0	0.1	-	0.1	-	0.1	V
		I _O = 20 μA; V _{CC} = 4.5 V	-	0	0.1	-	0.1	-	0.1	V
		I _O = 20 μA; V _{CC} = 6.0 V	-	0	0.1	-	0.1	-	0.1	V
		I _O = 4.0 mA; V _{CC} = 4.5 V	-	0.15	0.26	-	0.33	-	0.4	V
		I _O = 5.2 mA; V _{CC} = 6.0 V	-	0.16	0.26	-	0.33	-	0.4	V
II	input leakage current	$V_I = V_{CC}$ or GND; $V_{CC} = 6.0 \text{ V}$	-	-	±0.1	-	±1.0	-	±1.0	μΑ
I _{CC}	supply current	$V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 6.0 \text{ V}$	-	-	8.0	-	80	-	160	μΑ
Cı	input capacitance		-	3.5	-	-	-	-	-	pF

Symbol	Parameter	Conditions		25 °C			°C to 5 °C		°C to 5 °C	Unit
			Min	Тур	Max	Min	Max	Min	Max	
74HCT2	38-Q100							•		
V _{IH}	HIGH-level input voltage	V _{CC} = 4.5 V to 5.5 V	2.0	1.6	-	2.0	-	2.0	-	V
V _{IL}	LOW-level input voltage	V _{CC} = 4.5 V to 5.5 V	-	1.2	0.8	-	0.8	-	0.8	V
V _{OH}	HIGH-level	$V_I = V_{IH}$ or V_{IL} ; $V_{CC} = 4.5 V$								
	output voltage	I _O = -20 μA	4.4	4.5	-	4.4	-	4.4	-	V
		I _O = -4.0 mA	3.98	4.32	-	3.84	-	3.7	-	V
V _{OL}	LOW-level	$V_I = V_{IH}$ or V_{IL} ; $V_{CC} = 4.5 V$								
	output voltage	Ι _Ο = 20 μΑ	-	0	0.1	-	0.1	-	0.1	V
		I _O = 4.0 mA	-	0.16	0.26	-	0.33	-	0.4	V
l ₁	input leakage current	$V_I = V_{CC}$ or GND; $V_{CC} = 5.5 \text{ V}$	-	-	±0.1	-	±1.0	-	±1.0	μΑ
I _{CC}	supply current	$V_I = V_{CC}$ or GND; $V_{CC} = 5.5 \text{ V}$; $I_O = 0 \text{ A}$	-	-	8.0	-	80	-	160	μA
ΔI _{CC}	additional supply current	per input pin; $V_I = V_{CC} - 2.1 \text{ V}; I_O = 0 \text{ A};$ other inputs at V_{CC} or GND; $V_{CC} = 4.5 \text{ V}$ to 5.5 V								
		An inputs	-	70	252	-	315	-	343	μΑ
		Ē1, Ē2 inputs	-	40	144	-	180	-	196	μΑ
		E3 input	-	145	522	-	653	-	711	μΑ
Cı	input capacitance		-	3.5	-	-	-	-	-	pF

10. Dynamic characteristics

Table 7. Dynamic characteristics

GND = 0 V; test circuit see Fig. 8.

Symbol	Parameter	Conditions		25 °C			°C to 5 °C		°C to 5 °C	Unit
			Min	Тур	Max	Min	Max	Min	Max	
74HC23	8-Q100									
t _{pd}	propagation	An to Yn; see Fig. 6 [1]								
	delay	V _{CC} = 2.0 V	-	47	150	-	190	-	225	ns
		V _{CC} = 4.5 V	-	17	30	-	38	-	45	ns
		V _{CC} = 5.0 V; C _L = 15 pF	-	14	-	-	-	-	-	ns
		V _{CC} = 6.0 V	-	14	26	-	33	-	38	ns
		E3 to Yn; see Fig. 6 [1]								
		V _{CC} = 2.0 V	-	52	160	-	200	-	240	ns
		V _{CC} = 4.5 V	-	19	32	-	40	-	48	ns
		V _{CC} = 5.0 V; C _L = 15 pF	-	16	-	-	-	-	-	ns
		V _{CC} = 6.0 V	-	15	27	-	34	-	41	ns
		En to Yn or see Fig. 7 [1]								
		V _{CC} = 2.0 V	-	50	155	-	195	-	235	ns
		V _{CC} = 4.5 V	-	18	31	-	39	-	47	ns
		V _{CC} = 5.0 V; C _L = 15 pF	-	17	-	-	-	-	-	ns
		V _{CC} = 6.0 V	-	14	26	-	33	-	40	ns
t _t	transition time	see Fig. 6 and Fig. 7 [2]								
		V _{CC} = 2.0 V	-	19	75	-	95	-	110	ns
		V _{CC} = 4.5 V	-	7	15	-	19	-	22	ns
		V _{CC} = 6.0 V	-	6	13	-	16	-	19	ns
C _{PD}	power dissipation capacitance	per package; $V_I = GND$ to V_{CC} [3]	-	72	-	-	-	-	-	pF

Symbol	Parameter	Conditions			25 °C			°C to 5 °C	_	°C to 5 °C	Unit
				Min	Тур	Max	Min	Max	Min	Max	
74HCT2	38-Q100										
t _{pd}	propagation	An to Yn; see Fig. 6	[1]								
	delay	V _{CC} = 4.5 V		-	19	35	-	44	-	53	ns
		V _{CC} = 5.0 V; C _L = 15 pF		-	18	-	-	-	-	-	ns
		E3 to Yn; see Fig. 6	[1]								
		V _{CC} = 4.5 V		-	20	37	-	46	-	56	ns
		V _{CC} = 5.0 V; C _L = 15 pF		-	20	-	-	-	-	-	ns
		En to Yn or see Fig. 7	[1]								
		V _{CC} = 4.5 V		-	20	35	-	44	-	53	ns
		V _{CC} = 5.0 V; C _L = 15 pF		-	21	-	-	-	-	-	ns
t _t	transition time	V _{CC} = 4.5 V; see <u>Fig. 6</u> and <u>Fig. 7</u>	[2]	-	7	15	-	19	-	22	ns
C _{PD}	power dissipation capacitance	per package; V _I = GND to V _{CC} - 1.5 V	[3]	-	76	-	-	-	-	-	pF

- [1] t_{pd} is the same as t_{PHL} and t_{PLH} .
- [2] t_t is the same as t_{THL} and t_{TLH} .
- [3] C_{PD} is used to determine the dynamic power dissipation (P_D in μ W):

 $P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \sum_i (C_L \times V_{CC}^2 \times f_o)$ where:

 f_i = input frequency in MHz;

f_o = output frequency in MHz;

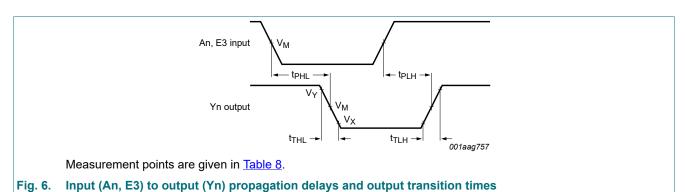
C_L = output load capacitance in pF;

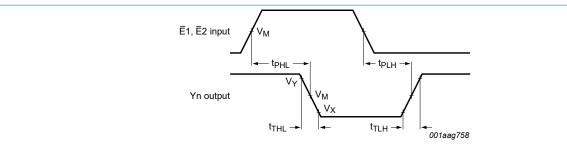
V_{CC} = supply voltage in V;

N = number of inputs switching;

 $\sum (C_L \times V_{CC}^2 \times f_0) = \text{sum of outputs.}$

10.1. Waveforms and test circuit



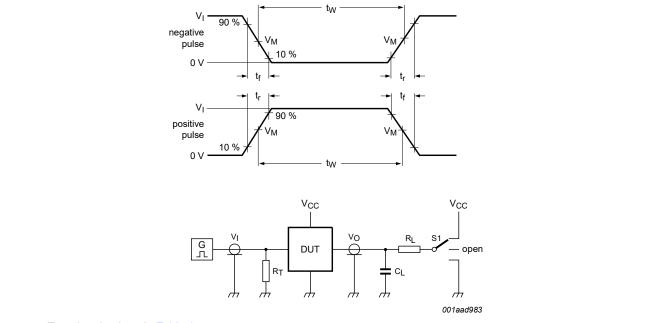


Measurement points are given in Table 8.

Fig. 7. Input ($\overline{E}1$, $\overline{E}2$) to output (Yn) propagation delays and output transition times

Table 8. Measurement points

Туре	Input	Output									
	V _M	V _M	V _X	V _Y							
74HC238-Q100	0.5V _{CC}	0.5V _{CC}	0.1V _{CC}	0.9V _{CC}							
74HCT238-Q100	1.3 V	1.3 V	0.1V _{CC}	0.9V _{CC}							



Test data is given in Table 9.

Definitions for test circuit:

 R_{T} = Termination resistance should be equal to output impedance Z_{o} of the pulse generator.

 $\ensuremath{\text{C}_{\text{L}}}$ = Load capacitance including jig and probe capacitance.

R_L = Load resistance.

S1 = Test selection switch

Fig. 8. Test circuit for measuring switching times

Table 9. Test data

Туре	Input		Load		S1 position
	V _I t _r , t _f		CL	R _L	t _{PHL} , t _{PLH}
74HC238-Q100	V _{CC}	6 ns	15 pF, 50 pF	1 kΩ	open
74HCT238-Q100	3 V	6 ns	15 pF, 50 pF	1 kΩ	open

11. Package outline

SO16: plastic small outline package; 16 leads; body width 3.9 mm

SOT109-1



UNIT	A max.	A ₁	A ₂	A ₃	bp	С	D ⁽¹⁾	E ⁽¹⁾	е	HE	L	Lp	Q	v	w	у	Z ⁽¹⁾	θ
mm	1.75	0.25 0.10	1.45 1.25	0.25	0.49 0.36	0.25 0.19	10.0 9.8	4.0 3.8	1.27	6.2 5.8	1.05	1.0 0.4	0.7 0.6	0.25	0.25	0.1	0.7 0.3	8°
inches	0.069	0.010 0.004	0.057 0.049	0.01		0.0100 0.0075	0.39 0.38	0.16 0.15	0.05	0.244 0.228	0.041	0.039 0.016	0.028 0.020	0.01	0.01	0.004	0.028 0.012	0°

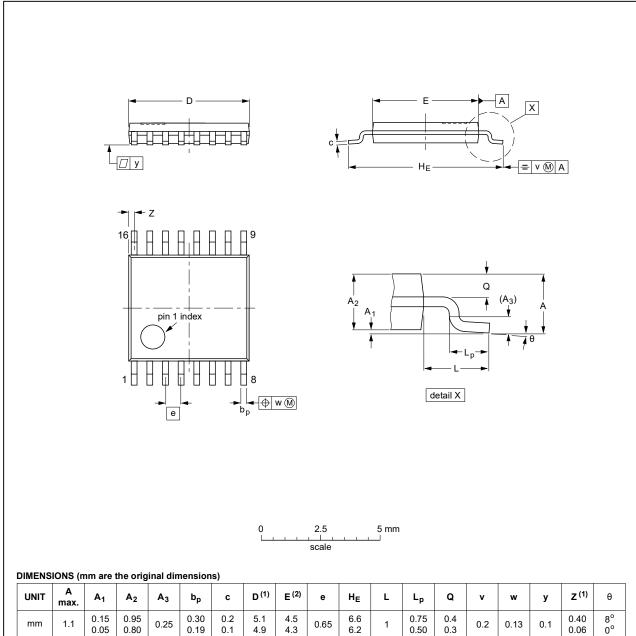
1. Plastic or metal protrusions of 0.15 mm (0.006 inch) maximum per side are not included.

OUTLINE	REFERENCES				EUROPEAN	ISSUE DATE
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE
SOT109-1	076E07	MS-012				99-12-27 03-02-19

Fig. 9. Package outline SOT109-1 (SO16)

TSSOP16: plastic thin shrink small outline package; 16 leads; body width 4.4 mm

SOT403-1



Notes

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

OUTLINE	REFERENCES				EUROPEAN	ISSUE DATE
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE
SOT403-1		MO-153				99-12-27 03-02-18

Fig. 10. Package outline SOT403-1 (TSSOP16)

DHVQFN16: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 16 terminals; body 2.5 x 3.5 x 0.85 mm SOT763-1

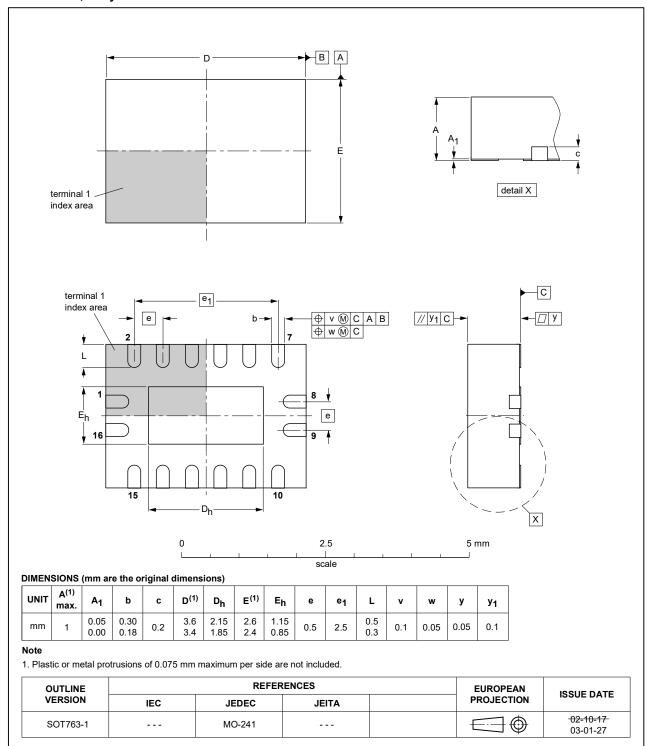


Fig. 11. Package outline SOT763-1 (DHVQFN16)

12. Abbreviations

Table 10. Abbreviations

Acronym	Description
CMOS	Complementary Metal Oxide Semiconductor
DUT	Device Under Test
ESD	ElectroStatic Discharge
НВМ	Human Body Model
MIL	Military
MM	Machine Model
TTL	Transistor-Transistor Logic

13. Revision history

Table 11. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes	
74HC_HCT238_Q100 v.3	20200403	Product data sheet	-	74HC_HCT238_Q100 v.2	
Modifications:	Section 2 uTable 4: De	pdated. rating values for P _{tot} total p	ower dissipation เ	updated.	
74HC_HCT238_Q100 v.2	20180613	Product data sheet	-	74HC_HCT238_Q100 v.1	
Modifications:	guidelines o Legal texts	 The format of this data sheet has been redesigned to comply with the identity guidelines of Nexperia. Legal texts have been adapted to the new company name where appropriate. Fig. 3: typo corrected. 			
74HC_HCT238_Q100 v.1	20130219	Product data sheet	-	-	

14. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions".
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